

Photocouplers Photorelay

TLP220GAF

1. Applications

- Mechanical relay replacements
- · Security Systems
- · Measuring Instruments
- Factory Automation (FA)
- · Amusement Equipment
- · Smart Meters
- · Electricity Meters

2. General

The TLP220GAF photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

3. Features

- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 400 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 120 mA (max)
- (5) ON-state resistance: $28 \Omega (\text{max}, t < 1s)$
- (6) ON-state resistance: 35 Ω (max, Continuous)
- (7) Isolation voltage: 5000 Vrms (min)
- (8) Safety standards

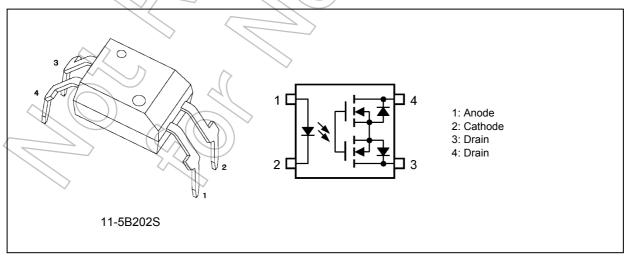
UL-approved: UL1577 File No. E67349

cUL-approved: CSA Component Acceptance Service No. 5A, File No. E67349

VDE-approved: Option (D4) EN60747-5-5 (Note)

Note: When an EN60747-5-5 approved type is needed, please designate the Option (D4)

4. Packaging and Pin Configuration





5. Internal Circuit

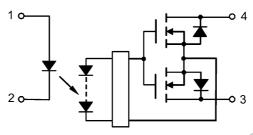


Fig. 5.1 Internal Circuit

6. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP220GA	10.16-mm Pitch TLP220GAF	Unit
Creepage distances	7.0 (min)	8.0 (min)	mm
Clearance distances	7.0 (min)	8.0 (min)	
Internal isolation thickness	0.4 (min)	0.4 (min)	(/ / /

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	I _F	\ \	30	mA
	Input forward current derating $(T_a \ge 25^{\circ}C)$	$\Delta I_{F}/\Delta T_{a}$		-0.3	mA/°C
	Input forward current (pulsed) (100 µs pulse, 100 pps)	JFP.		1	Α
	Input reverse voltage	VR		5	V
	Input power dissipation	P ₀		50	mW
	Junction temperature	√r _j		125	°C
Detector	OFF-state output terminal voltage	V _{OFF}		400	V
	ON-state current	I _{ON}		120	mA
	ON-state current derating $(T_a \ge 25^{\circ}C)$	ΔI _{ON} /ΔT _a		-1.2	mA/°C
	ON-state current (pulsed) (t = 100 ms, Duty = 1/10)	I _{ONP}		360	mA
	Output power dissipation	Po		500	mW
	Junction temperature	Tj		125	°C
Common	Storage temperature	T _{stg}		-55 to 125	
	Operating temperature	T _{opr}		-40 to 85	
	Lead soldering temperature (10 s)	T _{sol}		260	
	Isolation voltage AC, 1 min, R.H. ≤ 60%	BV _S	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.



8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V_{DD}		_		320	V
Input forward current	I _F		3	5	15	mA
ON-state current	I _{ON}	4	/		120	
Operating temperature	T _{opr}		-20		65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

9. Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I _R		V _R = 5 V		4	20	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_ <	40		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 400 V	-()+	1	μΑ
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	1	(80/)	/ –	pF

10. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 120 mA))—	0.3	2	mA
Return LED current	I _{FC}	4	I _{OFF} = 10 μA	0.1	_	_	mA
ON-state resistance	R _{ON}		I _{ON} = 120 mA, I _F = 5 mA, t < 1 s	_	17	28	Ω
		(Note 1)	I_{ON} = 120 mA, I_F = 5 mA, Continuous	_	22	35	

Note 1: Thermally saturated state.

11. Isolation Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _{\$} = 0 V, f = 1 MHz	_	0.8		pF
Isolation resistance	R_S	(Note 1)	V _S = 500 V, R.H. ≤ 60%	1 × 10 ¹²	1014	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 1 min	5000	_	_	Vrms
	<		AC, 1s in oil	_	10000		
\sim			DC, 1 min, in oil	_	10000		Vdc

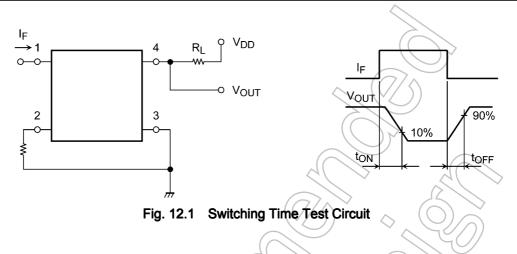
Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

Rev.2.0



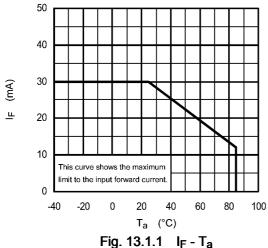
12. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

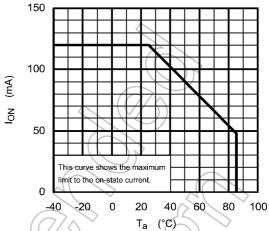
Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t _{ON}		See Fig. 12.1.	_	0.2	1	ms
Turn-off time	t _{OFF}		$R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$	_	0.2	1	

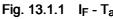


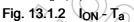
13. Characteristics Curves

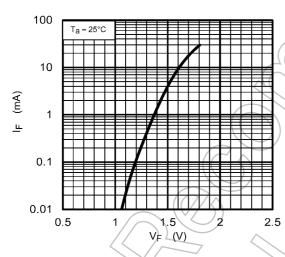
13.1. Characteristics Curves (Note)











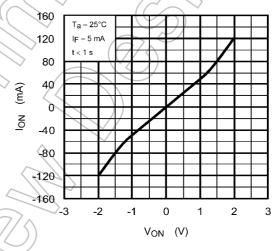
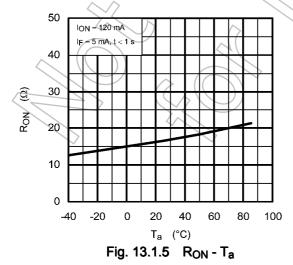


Fig. 13.1.3 IF - VF

Fig. 13.1.4 I_{ON} - V_{ON}



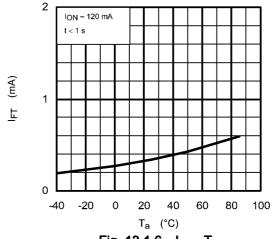


Fig. 13.1.6 I_{FT} - T_a

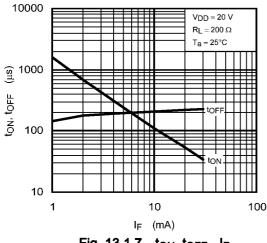


Fig. 13.1.7 t_{ON} , t_{OFF} - I_F

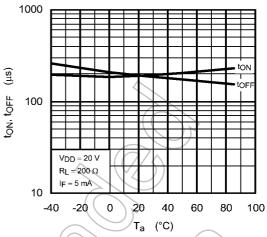
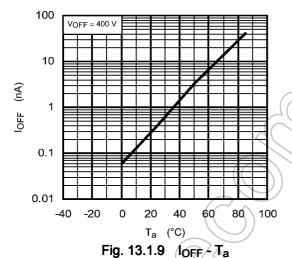
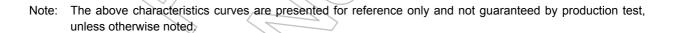


Fig. 13.1.8 toN, toFF - Ta

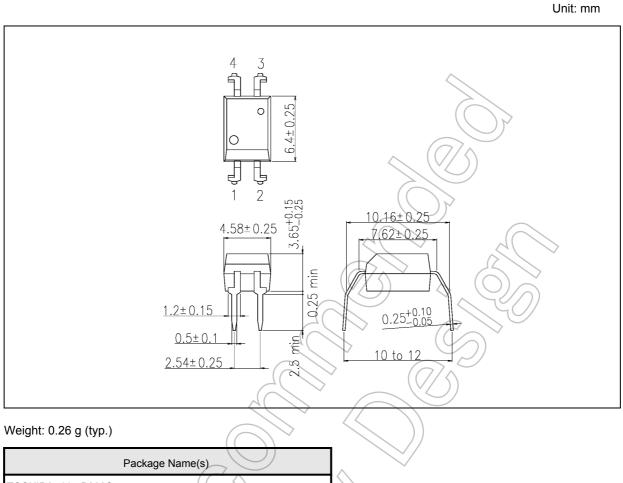


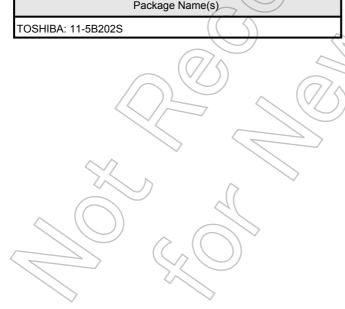






Package Dimensions







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